

SGH80T65SMD

650V 80A FieldStop Trench IGBT

Features

- FieldStop Trench Technology, Positive temperature coefficient
- $V_{CE(sat)}=1.45V@I_C=80A$
- $t_{rr}=50ns$ (typ.)
- High Speed Switching & Low Power Loss
- High Input Impedance

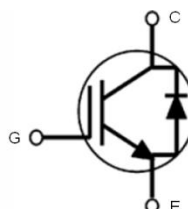
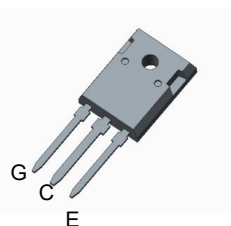
Applications

- PFC, UPS, Welder, PV Inverter, Solar Inverter

Description

The device is designed by advanced FieldStop Trench technology process. This IGBT offer low $V_{CE(sat)}$, high speed switching performance and excellent quality for application such as PFC, UPS, Welder, PV Inverter, Solar Inverter and other switching applications.

Package Type & Internal Circuit



Device	Package type	Description of Marking
SGH80T65SMD	TO-247	G80T65D

Absolute Maximum Ratings

Symbol	Parameter		Ratings	Unit
V _{CES}	Collector to Emitter Voltage		650	V
V _{GES}	Gate to Emitter Voltage		±20	V
I _C	Collector Current	T _C =25°C	160	A
		T _C =100°C	80	A
I _{CM}	Pulsed Collector Current		240	A
I _F	Diode Continuous Forward Current	T _C =100°C	80	A
I _{FM}	Diode Maximum Forward Current		400	A
P _D	Maximum Power Dissipation	T _C =25°C	428	W
		T _C =100°C	214	W
T _J	Operating Junction Temperature Range		-50~+175	°C
T _{STG}	Storage Temperature Range		-50~+150	°C

Thermal Characteristics

Symbol	Parameter	Ratings	Unit
$R_{th(J-C)}$ (IGBT)	Thermal Resistance, Junction to case for IGBT	0.35	$^{\circ}C/W$
$R_{th(J-C)}$ (Diode)	Thermal Resistance, Junction to case for Diode	0.45	$^{\circ}C/W$
$R_{th(J-A)}$	Thermal Resistance, Junction to Ambient	40	$^{\circ}C/W$

**Electrical Characteristics of IGBT** @ $T_C=25\text{ }^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{CES}	Collector to Emitter Breakdown Voltage	$V_{GE}=0V, I_C=250\mu A$	650	-	-	V
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=80A, V_{GE}=15V$	-	1.45	1.8	V
		$I_C=80A, V_{GE}=15V, T_C=125^{\circ}\text{C}$	-	1.7	-	V
$V_{GE(th)}$	Gate Threshold Voltage	$V_{CE}=V_{GE}, I_C=250\mu A$	4.0	4.5	6.0	V
I_{CES}	Zero Gate Voltage Collector Current	$V_{CE}=V_{CES}, V_{GE}=0V$	-	-	10	μA
I_{GES}	Gate to Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0V$	-	-	± 250	nA

Electrical Characteristics of Diode @ $T_C=25\text{ }^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V_F	Diode Forward Voltage	$I_F=80A$	-	1.66	1.9	V
		$I_F=80A, T_C=125^{\circ}\text{C}$	-	1.5	-	V
t_{rr}	Diode Reverse Recovery Time	$I_F=80A, di/dt=-200A/\mu s$	-	50.0	75.0	ns
I_{rr}	Diode Peak Reverse Recovery Current		-	9.0	-	A
Q_{rr}	Diode Reverse Recovery Charge		-	1.4	-	nC

Switching Characteristics @ $T_C=25\text{ }^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on Delay Time	$I_C=80A, V_{CC}=325V, V_{GE}=15V, R_G=7\Omega, \text{Inductive Load}, T_C=25^{\circ}\text{C}$	-	31.4	-	ns
t_r	Rising Time		-	38.2	-	ns
$t_{d(off)}$	Turn-off Delay Time		-	133.6	-	ns
t_f	Falling Time		-	38.8	-	ns
E_{on}	Turn-on Switching Loss		-	1.50	-	mJ
E_{off}	Turn-off Switching Loss		-	0.69	-	mJ
E_{ts}	Total Switching Loss		-	2.17	-	mJ
$t_{d(on)}$	Turn-on Delay Time	$I_C=80A, V_{CC}=325V, V_{GE}=15V, R_G=7\Omega, \text{Inductive Load}, T_C=125^{\circ}\text{C}$	-	30.8	-	ns
t_r	Rising Time		-	61.4	-	ns
$t_{d(off)}$	Turn-off Delay Time		-	144.2	-	ns
t_f	Falling Time		-	54.0	-	ns
E_{on}	Turn-on Switching Loss		-	2.00	-	mJ
E_{off}	Turn-off Switching Loss		-	1.12	-	mJ
E_{ts}	Total Switching Loss		-	3.02	-	mJ
C_{ies}	Input Capacitance	$V_{GE}=0V, V_{CE}=25V, f=1.0\text{MHz}$	-	3680	-	pF
C_{res}	Reverse Transfer Capacitance		-	109	-	pF
C_{oes}	Output Capacitance		-	15	-	pF
t_{sc}	Short Circuit With stand Time	$V_{CC}=325V, V_{GE}=15V$	10	-	-	us

Typical Performance Characteristics

Fig. 1. Typical Output Characteristics

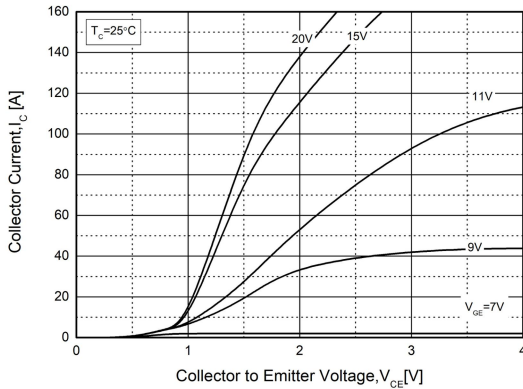


Fig. 2. Typical Saturation Voltage Characteristics

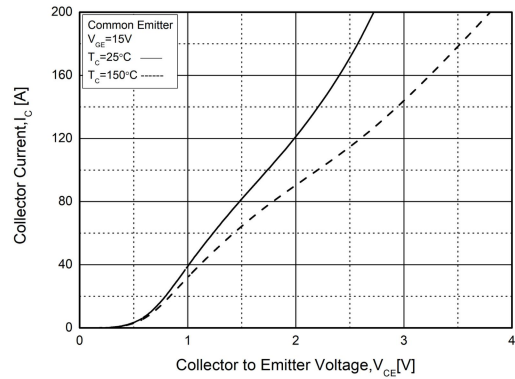


Fig. 3. Typical Saturation Voltage vs. T_C

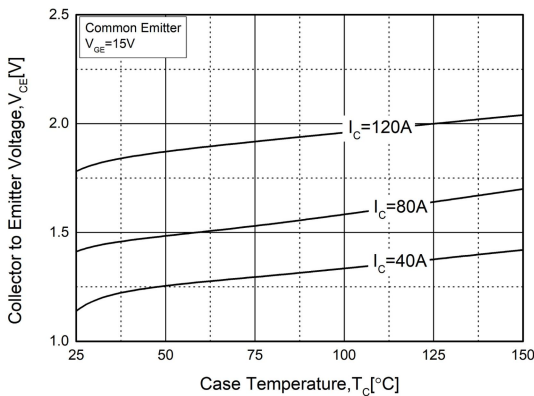


Fig. 4. Diode Forward Characteristics

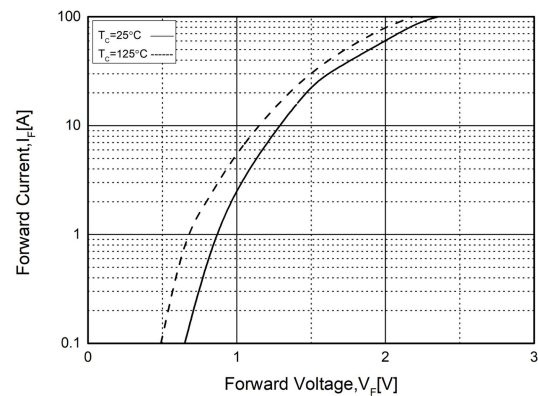


Fig. 5. Typical Capacitance Characteristics

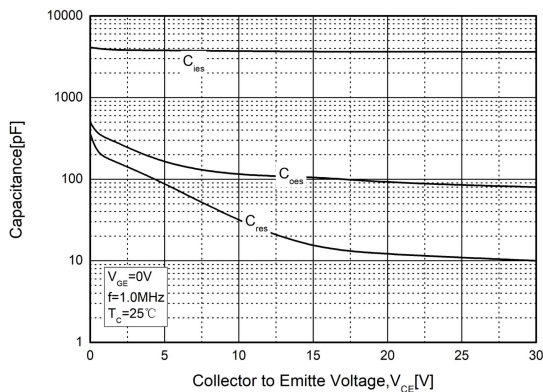
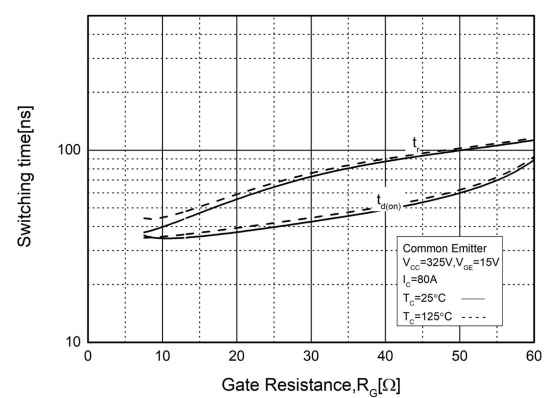
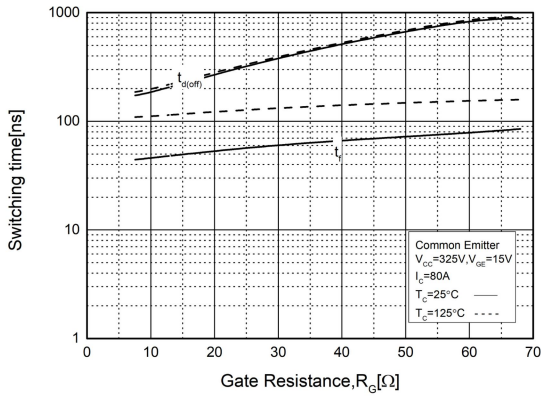
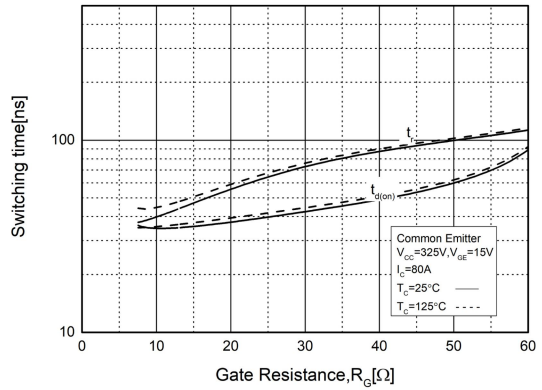
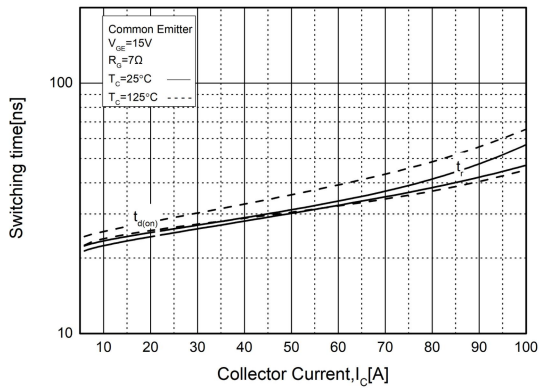
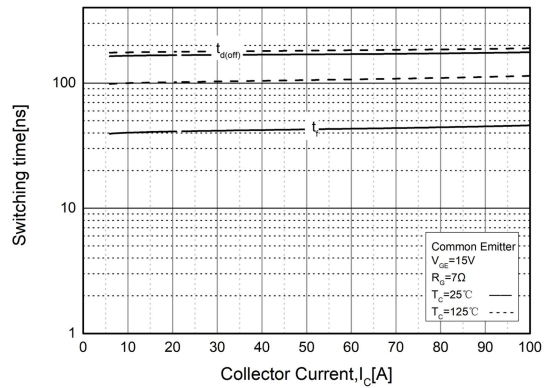
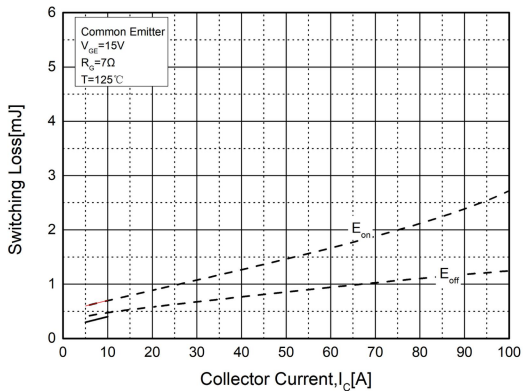


Fig. 6. Turn-on Characteristics vs. R_G



Typical Performance Characteristics

Fig. 7. Turn-off Characteristics vs. R_G

Fig. 8. Switching Loss vs. R_G

Fig. 9. Turn-on Characteristics vs. I_C

Fig. 10. Turn-off Characteristics vs. I_C

Fig. 11. Switching Loss vs. I_C


Package Dimensions

TO-247

(Dimensions in Millimeters)

